

Dual N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- Surface-mounted package
- Extremely low threshold voltage
- Advanced trench cell design
- ESD protected

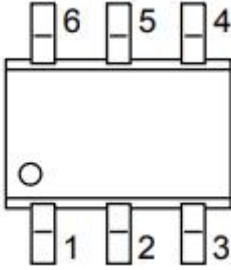
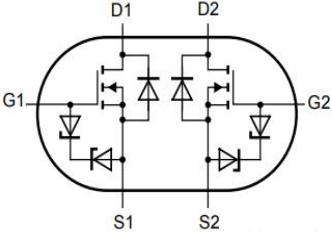
1.2 Applications

- Portable appliances

1.3 Quick reference

- $BV \geq 60\text{ V}$
- $R_{DS(ON)} \leq 2\ \Omega @ V_{GS} = 10\text{ V}$
- $P_{tot} \cong 1.33\text{ W}$
- $R_{DS(ON)} \leq 2.7\ \Omega @ V_{GS} = 4.5\text{ V}$
- $I_D \cong 0.8\text{ A}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Source(S1)	 Top View SOT363	
2	Gate(G1)		
3	Drain(D2)		
4	Source(S2)		
5	Gate(G2)		
6	Drain(D2)		

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_A = 25\text{ }^{\circ}\text{C}$	60	-	V
V_{GS}	Gate-Source Voltage	$T_A = 25\text{ }^{\circ}\text{C}$	-	± 20	V
I_D^*	Drain Current	$T_A = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$	-	0.8	A
$I_{DM}^{*,**}$	Pulsed Drain Current	$T_A = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$	-	2	A
P_{tot}^*	Total Power Dissipation	$T_A = 25\text{ }^{\circ}\text{C}$	-	0.83	W
T_{stg}	Storage Temperature		- 55	150	$^{\circ}\text{C}$
T_J	Junction Temperature		-	150	$^{\circ}\text{C}$
I_S^*	Diode Forward Current	$T_A = 25\text{ }^{\circ}\text{C}$	-	0.8	A
$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient		-	150	$^{\circ}\text{C} / \text{W}$

Notes :

- * Surface Mounted on 1 in² pad area, $t \leq 10\text{ sec}$
- ** Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- *** Limited by bonding wire

4. Marking Information

Product Name	Marking
KJ2N7002KS3	<div style="display: inline-block; border: 1px solid black; padding: 2px;"> 702 S3 YWWXXX </div> YWW: Date Code

5. Ordering Code

Product Name	Package	Reel Size	Tape width	Quantity	Note
KJ2N7002KS3	SOT363				

Note: KUAJIEXIN defines " Green " as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C)

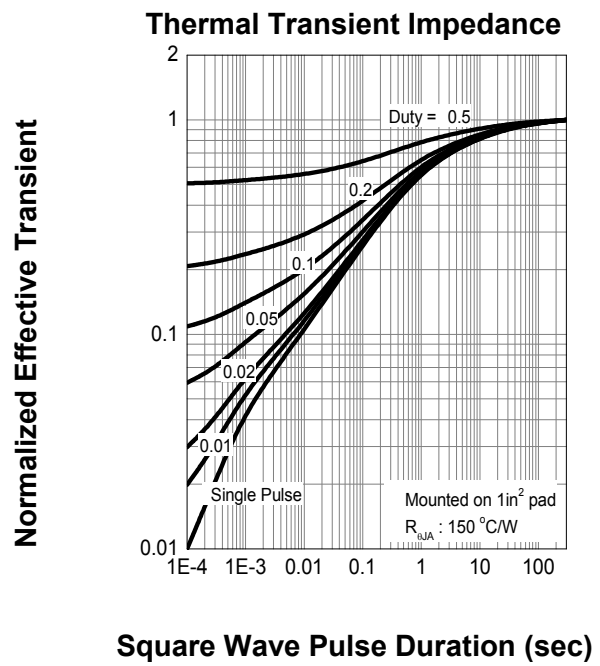
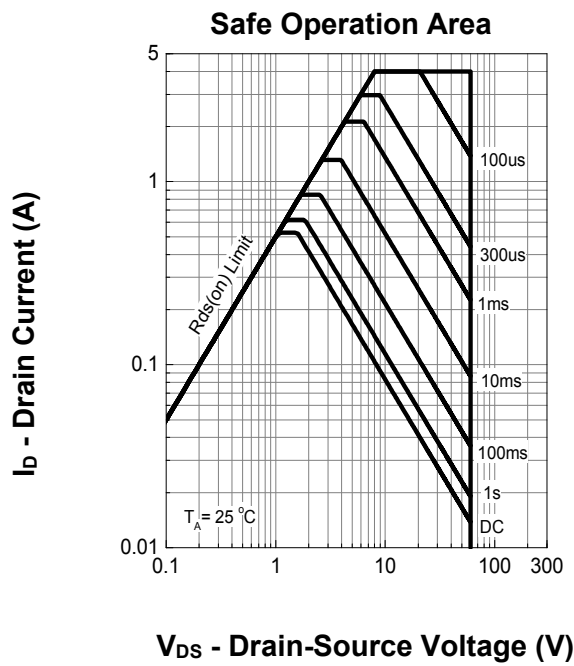
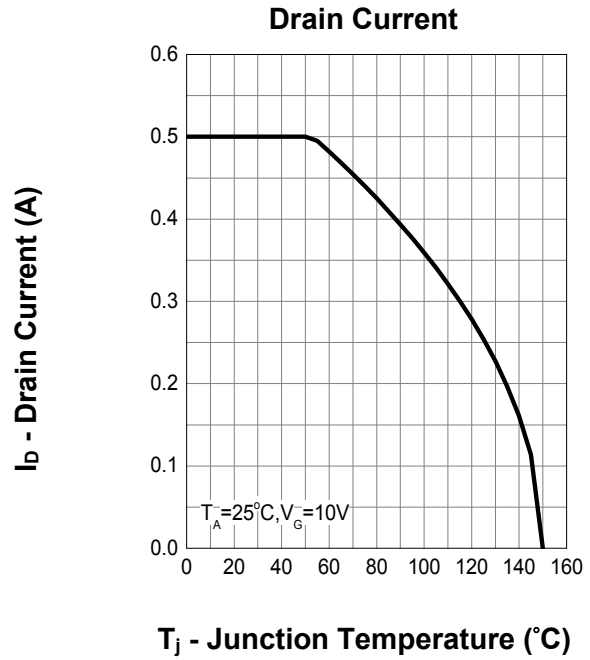
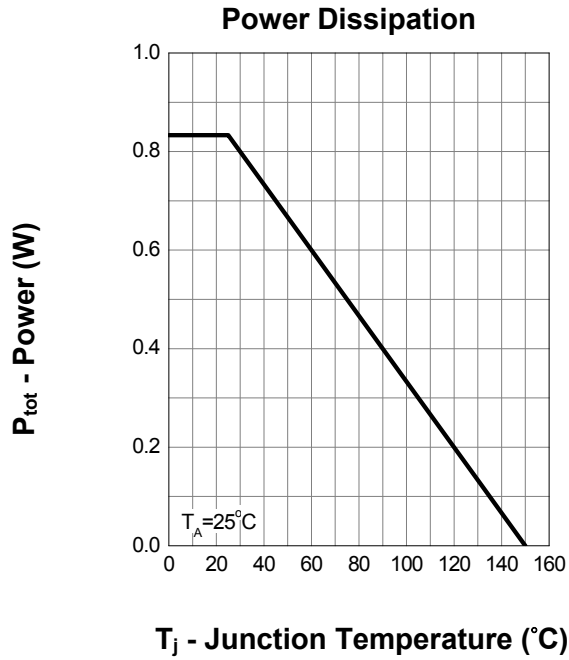
6. Electrical Characteristics ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 250\text{ }\mu\text{A}$	60	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{DS} = 250\text{ }\mu\text{A}$	1	1.5	2	V
I_{DSS}	Drain Leakage Current	$V_{DS} = 48\text{ V}, V_{GS} = 0\text{ V}$	-	-	1	μA
I_{GSS}	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	-	± 0.8	-	μA
$R_{DS(ON)}^a$	On-State Resistance	$V_{GS} = 10\text{ V}, I_{DS} = 0.5\text{ A}$	-	1.5	2	Ω
		$V_{GS} = 4.5\text{ V}, I_{DS} = 0.2\text{ A}$	-	2.0	2.7	
Diode Characteristics						
V_{SD}^a	Diode Forward Voltage	$I_{SD} = 0.5\text{ A}, V_{GS} = 0\text{ V}$	-	0.85	-	V
t_{rr}	Reverse Recovery Time	$I_{SD} = 0.5\text{ A}, dI_{SD}/dt = 100\text{ A}/\mu\text{s}$	-	30	-	ns
Q_{rr}	Reverse Recovery Charge		-	29	-	nC
Dynamic Characteristics^b						
R_G	Gate Resistance	$V_{GS} = V_{DS} = 0\text{ V}, F = 1\text{ MHz}$	-	200	-	Ω
C_{iss}	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}$ Frequency = 1 MHz	-	14.7	-	pF
C_{oss}	Output Capacitance		-	0.76	-	
C_{rss}	Reverse Transfer Capacitance		-	0.63	-	
$t_d(on)$	Turn-on Delay Time	$V_{DS} = 30\text{ V}, V_{GEN} = 10\text{ V},$ $R_G = 25\text{ }\Omega, R_L = 60\text{ }\Omega,$ $I_{DS} = 0.5\text{ A}$	-	2.7	-	ns
t_r	Turn-on Rise Time		-	2.5	-	
$t_d(off)$	Turn-off Delay Time		-	13	-	
t_f	Turn-off Fall Time		-	8	-	
Q_g	Total Gate Charge	$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V},$ $I_{DS} = 0.5\text{ A}$	-	0.44	-	nC
Q_{gs}	Gate-Source Charge		-	0.2	-	
Q_{gd}	Gate-Drain Charge		-	0.1	-	

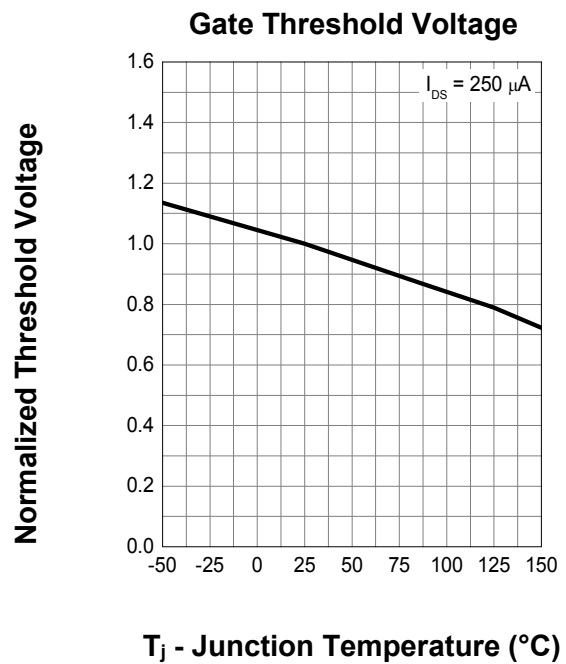
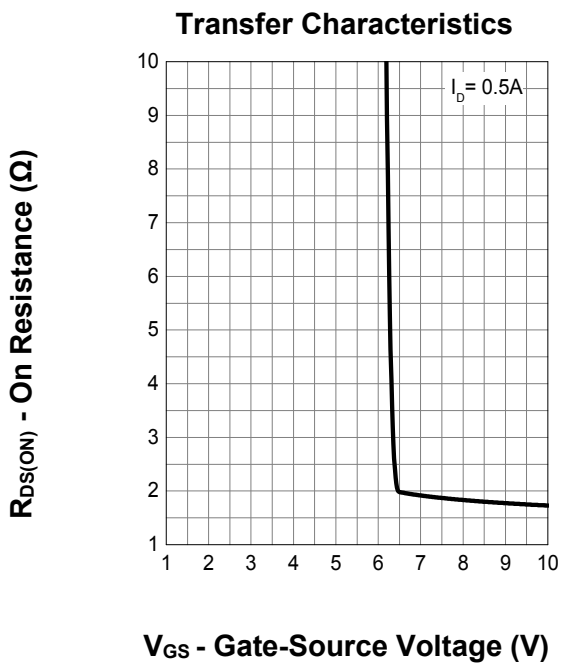
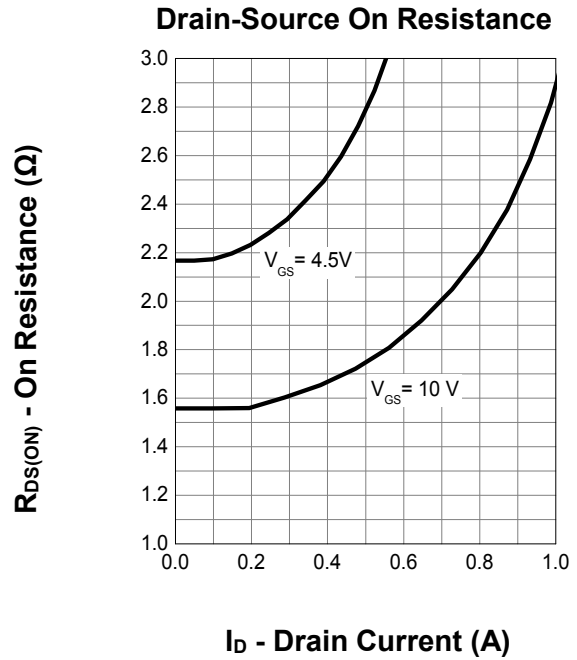
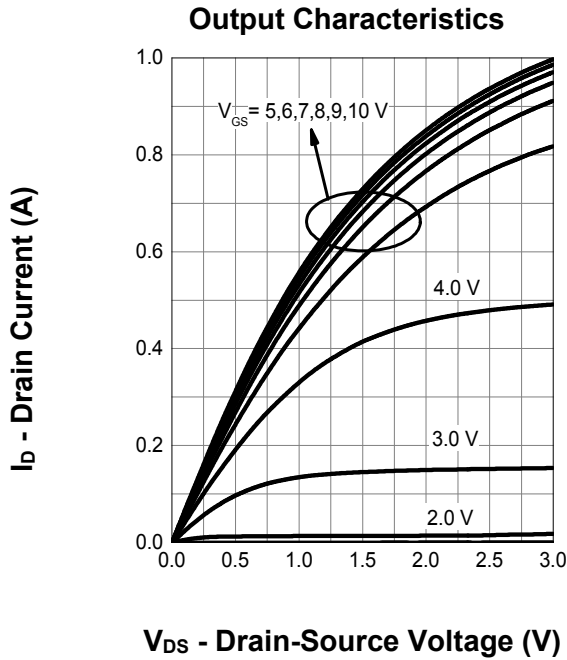
Notes :

- a : Pulse test ; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- b : Guaranteed by design, not subject to production testing

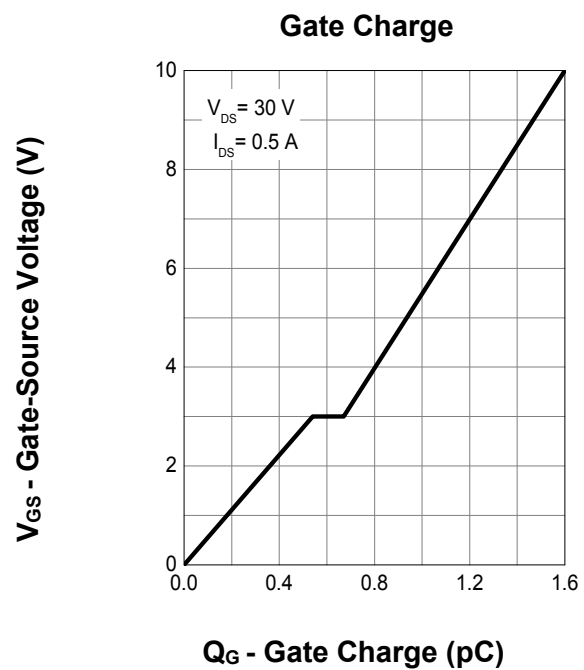
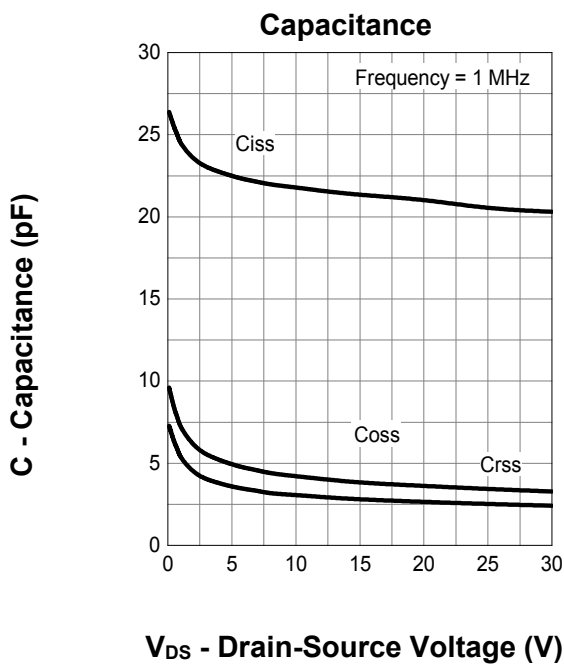
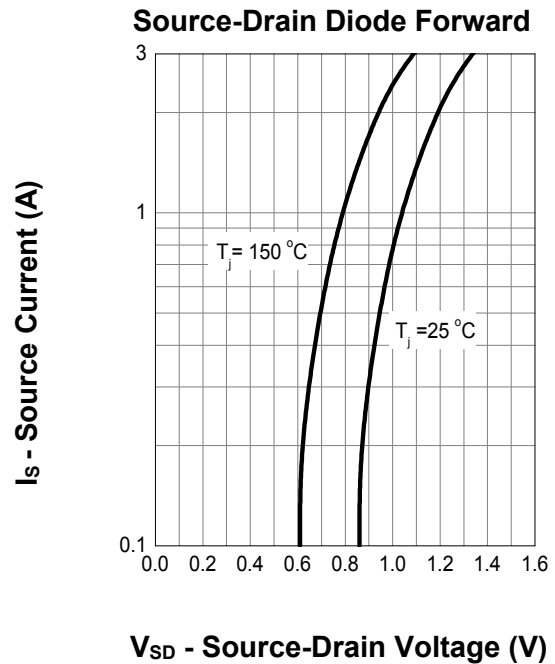
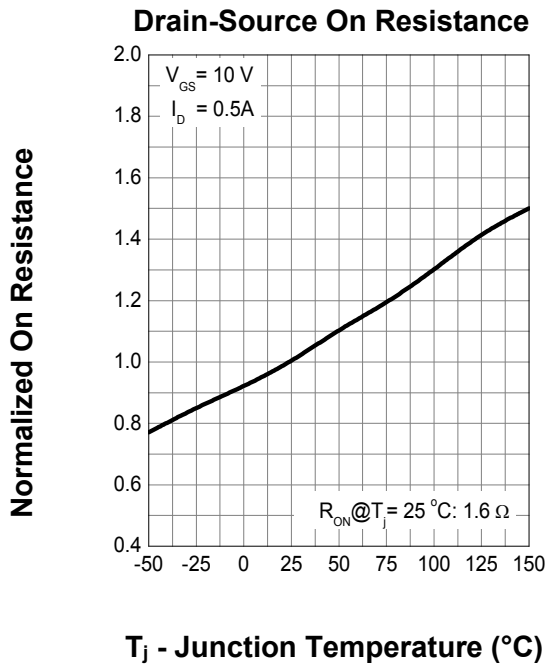
7. Typical Characteristics



7. Typical Characteristics (cont.)



7. Typical Characteristics (cont.)



8. Package Dimensions

SOT363

